## High Temperature Accuracy Integrated Silicon Pressure Sensor On-Chip Signal Conditioned, Temperature Compensated and Calibrated

Motorola's MPXV6115VC6U sensor integrates on-chip, bipolar op amp circuitry and thin film resistor networks to provide a high output signal and temperature compensation. The small form factor and high reliability of on-chip integration make the Motorola pressure sensor a logical and economical choice for the system designer.

The MPXV6115VC6U piezoresistive transducer is a state-of-the-art, monolithic, signal conditioned, silicon pressure sensor. This sensor combines advanced micromachining techniques, thin film metallization, and bipolar semiconductor processing to provide an accurate, high level analog output signal that is proportional to applied pressure.

Figure 1 shows a block diagram of the internal circuitry integrated on a pressure sensor chip.

## Features

- Improved Accuracy at High Temperature
- $1.5 \%$ Maximum Error over $0^{\circ}$ to $85^{\circ} \mathrm{C}$
- Ideally suited for Microprocessor or Microcontroller-Based Systems
- Temperature Compensated from $-40^{\circ}$ to $+125^{\circ} \mathrm{C}$
- Durable Thermoplastic (PPS) Surface Mount Package


## Application Examples

- Vacuum Pump Monitoring
- Brake Booster Monitoring


Figure 1. Fully Integrated Pressure Sensor
Schematic

## MPXV6115VC6U

NOTE: Pins $1,5,6,7$, and 8 are internal device connections. Do not connect to external circuitry or ground. Pin 1 is denoted by the notch in the lead.

## MPXV6115VC6U

Freescale Semiconductor, Inc.
MAXIMUM RATINGS ${ }^{(1)}$

| Parametrics | Symbol | Value | Units |
| :--- | :---: | :---: | :---: |
| Maximum Pressure (P1 > P2) | $\mathrm{P}_{\max }$ | 400 | kPa |
| Storage Temperature | $\mathrm{T}_{\text {stg }}$ | $-40^{\circ}$ to $+125^{\circ}$ | ${ }^{\circ} \mathrm{C}$ |
| Operating Temperature | $\mathrm{T}_{\mathrm{A}}$ | $-40^{\circ}$ to $+125^{\circ}$ | ${ }^{\circ} \mathrm{C}$ |
| Output Source Current @ Full Scale Output ${ }^{(2)}$ | $\mathrm{I}_{0}+$ | 0.5 | mAdc |
| Output Sink Current @ Minimum Pressure Offset ${ }^{(2)}$ | $\mathrm{I}_{0}-$ | -0.5 | mAdc |

NOTES:

1. Exposure beyond the specified limits may cause permanent damage or degradation to the device.
2. Maximum Output Current is controlled by effective impedance from $\mathrm{V}_{\text {out }}$ to $G$ nd or $\mathrm{V}_{\text {out }}$ to $\mathrm{V}_{\mathrm{S}}$ in the application circuit.

OPERATING CHARACTERISTICS $\left(\mathrm{V}_{\mathrm{S}}=5.0 \mathrm{Vdc}, \mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}\right.$ unless otherwise noted, $\mathrm{P} 1>\mathrm{P} 2$.)

| Characteristic |  | Symbol | Min | Typ | Max | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Pressure Range |  | Pop | -115 | - | 0 | kPa |
| Supply Voltage ${ }^{(1)}$ |  | $\mathrm{V}_{\mathrm{S}}$ | 4.75 | 5.0 | 5.25 | Vdc |
| Supply Current |  | $\mathrm{I}_{0}$ | - | 6.0 | 10 | mAdc |
| Full Scale Output ${ }^{(2)}$ <br> @ $\mathrm{V}_{\mathrm{S}}=5.0$ Volts | $\begin{aligned} & \left(0 \text { to } 85^{\circ} \mathrm{C}\right) \\ & \left(\mathrm{P}_{\text {diff }}=0 \mathrm{kPa}\right) \end{aligned}$ | $\mathrm{V}_{\text {FSO }}$ | 4.534 | 4.6 | 4.665 | Vdc |
| Full Scale Span ${ }^{(3)}$ <br> @ $\mathrm{V}_{\mathrm{S}}=5.0$ Volts | (0 to $85^{\circ} \mathrm{C}$ ) | $\mathrm{V}_{\text {FSS }}$ | - | 4.4 | - | Vdc |
| Accuracy ${ }^{(4)}$ | (0 to $85^{\circ} \mathrm{C}$ ) | - | - | - | $\pm 1.5$ | \% $\mathrm{V}_{\text {FSS }}$ |
| Sensitivity |  | V/P | - | 38.26 | - | $\mathrm{mV} / \mathrm{kPa}$ |
| Response Time ${ }^{(5)}$ |  | $t_{R}$ | - | 1.0 | - | ms |
| Warm-Up Time ${ }^{(6)}$ |  | - | - | 20 | - | ms |
| Offset Stability ${ }^{(7)}$ |  | - | - | $\pm 0.5$ | - | \% $\mathrm{V}_{\text {FSS }}$ |

NOTES:

1. Device is ratiometric within this specified excitation range.
2. Full Scale Output ( $\mathrm{V}_{\mathrm{FSO}}$ ) is defined as the output voltage at the maximum or full rated pressure.
3. Full Scale Span ( $\mathrm{V}_{\mathrm{FSS}}$ ) is defined as the algebraic difference between the output voltage at full rated pressure and the output voltage at the minimum rated pressure.
4. Accuracy is the deviation in actual output from nominal output over the entire pressure range and temperature range as a percent of span at $25^{\circ} \mathrm{C}$ due to all sources of error including the following:

- Linearity: Output deviation from a straight line relationship with pressure over the specified pressure range.
- Temperature Hysteresis: Output deviation at any temperature within the operating temperature range, after the temperature is cycled to and from the minimum or maximum operating temperature points, with zero differential pressure applied.
- Pressure Hysteresis: Output deviation at any pressure within the specified range, when this pressure is cycled to and from minimum or maximum rated pressure at $25^{\circ} \mathrm{C}$.
- TcSpan: Output deviation over the temperature range of $0^{\circ}$ to $85^{\circ} \mathrm{C}$, relative to $25^{\circ} \mathrm{C}$.
- TcOffset: Output deviation with minimum pressure applied, over the temperature range of $0^{\circ}$ to $85^{\circ} \mathrm{C}$, relative to $25^{\circ} \mathrm{C}$.

5. Response Time is defined as the time for the incremental change in the output to go from $10 \%$ to $90 \%$ of its final value when subjected to a specified step change in pressure.
6. Warm-up Time is defined as the time required for the product to meet the specified output voltage after the pressure has been stabilized.
7. Offset Stability is the product's output deviation when subjected to 1000 cycles of Pulsed Pressure, Temperature Cycling with Bias Test.


Figure 3. Typical Application Circuit (Output Source Current Operation)

Figure 2 illustrates the absolute sensing chip in the basic Small Outline chip carrier (Case 482).

Figure 3 shows a typical application circuit (output source current operation).


Figure 4. Output versus Absolute Pressure

Figure 4 shows the sensor output signal relative to pressure input. Typical minimum and maximum output curves are shown for operation over 0 to $85^{\circ} \mathrm{C}$ temperature range. The output will saturate outside of the rated pressure range.

A fluorosilicone gel isolates the die surface and wire bonds from the environment, while allowing the pressure signal to be transmitted to the silicon diaphragm. The

MPXV6115VC6U pressure sensor operating characteristics, internal reliability and qualification tests are based on use of dry air as the pressure media. Media other than dry air may have adverse effects on sensor performance and long-term reliability. Contact the factory for information regarding media compatibility in your application.

Transfer Function (MPXV6115VC6U)
Nominal Transfer Value: $\mathrm{V}_{\text {out }}=\mathrm{V}_{\mathrm{S}} \times(0.007652 \times \mathrm{P}+0.92)$
$\pm$ (Pressure Error $\times$ Temp. Factor $\times 0.007652 \times \mathrm{V}_{\mathrm{S}}$ )
$\mathrm{V}_{\mathrm{S}}=5.0 \pm 0.25 \mathrm{Vdc}$


Pressure Error Band


ORDERING INFORMATION — SMALL OUTLINE PACKAGE

| Device Type | Options | Case No. | MPX Series Order No. | Packing Options | Marking |
| :---: | :---: | :---: | :--- | :--- | :---: |
| Ported Element | Vacuum, Axial Port | 482 A | MPXV6115VC6U | Rails | MPXV6115V |

## SURFACE MOUNTING INFORMATION

## MINIMUM RECOMMENDED FOOTPRINT FOR SMALL OUTLINE PACKAGE

Surface mount board layout is a critical portion of the total design. The footprint for the semiconductor package must be the correct size to ensure proper solder connection interface between the board and the package. With the correct pad geometry, the packages will self-align when subjected to
a solder reflow process. It is always recommended to fabricate boards with a solder mask layer to avoid bridging and/or shorting between solder pads, especially on tight tolerances and/or tight layouts.


Figure 5. SOP Footprint (Case 482A)


NOTES:

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: INCH
3. DIMENSION A AND B DO NOT INCLUDE MOLD PROTRUSION.
4. MAXIMUM MOLD PROTRUSION $0.15(0.006)$
5. MAXIMUM MOLD PROTRUSION 0.15 ( 0.006 ).
6. ALL VERTICAL SURFACES $5^{\circ}$ TYPICAL DRAFT.

| DIM | INCHES |  | MILLIMETERS |  |
| :---: | ---: | ---: | ---: | :---: |
|  | MIN | MAX | MIN | MAX |
| A | 0.415 | 0.425 | 10.54 | 10.79 |
| B | 0.415 | 0.425 | 10.54 | 10.79 |
| C | 0.500 | 0.520 | 12.70 | 13.21 |
| D | 0.038 | 0.042 | 0.96 |  |
| G | 0.100 BSC |  | 2.54 BSC |  |
| H | 0.002 | 0.010 | 0.05 | 0.25 |
| J | 0.009 | 0.011 | 0.23 | 0.28 |
| K | 0.061 | 0.071 | 1.55 | 1.80 |
| M | $0{ }^{\circ}$ | $7^{\circ}$ | $0{ }^{\circ}$ | $7^{\circ}$ |
| N | 0.444 | 0.448 | 11.28 | 11.38 |
| S | 0.709 | 0.725 | 18.01 | 18.41 |
| V | 0.245 | 0.255 | 6.22 | 6.48 |
| W | 0.115 | 0.125 | 2.92 | 3.17 |

CASE 482A-01
ISSUE A


#### Abstract

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